## **BT169W Series**

## GENERAL DESCRIPTION

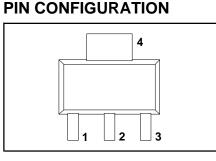
Glass passivated, sensitive gate thyristor in a plastic envelope, suitable for surface mounting, intended for use in general purpose switching and phase control applications. This device is intended to be interfaced directly to microcontrollers, logic integrated circuits and other low power gate trigger circuits.

## QUICK REFERENCE DATA

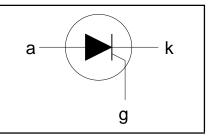
SYMBOL	PARAMETER	MAX.	MAX.	MAX.	MAX.	UNIT
V <sub>drm</sub> , V <sub>rrm</sub>	BT169 Repetitive peak off-state voltages	<b>BW</b> 200	<b>DW</b> 400	<b>EW</b> 500	<b>GW</b> 600	V
I <sub>T(AV)</sub>	Average on-state	0.5	0.5	0.5	0.5	A
I <sub>T(RMS)</sub> I <sub>TSM</sub>	RMS on-state current Non-repetitive peak on-state current	0.8 8	0.8 8	0.8 8	0.8 8	A A

#### **PINNING - SOT223**

PIN	DESCRIPTION
1	cathode
2	anode
3	gate
tab	anode



## SYMBOL



## LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.		MA	<b>λΧ</b> .		UNIT
$V_{drm}, V_{rrm}$	Repetitive peak off-state voltages		-	<b>B</b> 200 <sup>1</sup>	<b>D</b> 400 <sup>1</sup>	<b>E</b> 500 <sup>1</sup>	<b>G</b> 600 <sup>1</sup>	V
I <sub>T(AV)</sub>	Average on-state current	half sine wave; T₅₅ ≤ 112 °C	-		0.	63		A
I <sub>T(RMS)</sub> I <sub>TSM</sub>	RMS on-state current Non-repetitive peak on-state current	all conduction angles half sine wave; $T_i = 25 \degree C$ prior to surge	-			1		A
		t = 10 ms t = 8.3 ms	-		5	3 9		A
l²t dl <sub>⊤</sub> /dt	I <sup>2</sup> t for fusing Repetitive rate of rise of on-state current after triggering		-			32 0		A <sup>2</sup> s A/μs
I <sub>GM</sub> V <sub>GM</sub> V <sub>RGM</sub> P <sub>GM</sub>	Peak gate current Peak gate voltage Peak reverse gate voltage Peak gate power		- - -			1 5 5 2		A V V W
$\begin{array}{c} P_{G(AV)}^{C(AV)} \\ T_{stg} \\ T_{j} \end{array}$	Average gate power Storage temperature Operating junction temperature	over any 20 ms period	- -40 -		1:	.1 50 25		°℃ ℃

<sup>1</sup> Although not recommended, off-state voltages up to 800V may be applied without damage, but the thyristor may switch to the on-state. The rate of rise of current should not exceed 15  $A/\mu s$ .

## **BT169W Series**

#### THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
R <sub>th j-sp</sub>	Thermal resistance junction to solder point		-	-	15	K/W
R <sub>th j-a</sub>		pcb mounted, minimum footprint pcb mounted; pad area as in fig:14	-	156 70	-	K/W K/W

#### STATIC CHARACTERISTICS

 $T_i = 25$  °C unless otherwise stated

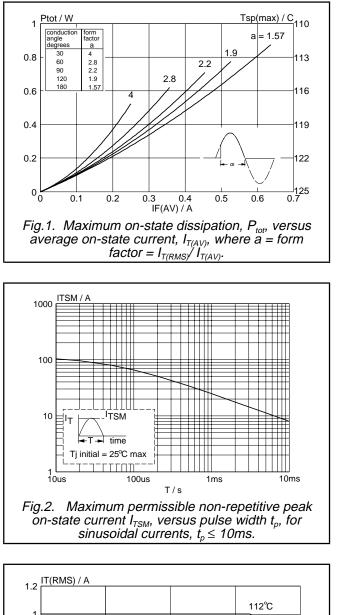
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I <sub>GT</sub>	Gate trigger current	$V_{\rm D}$ = 12 V; I <sub>T</sub> = 10 mA; gate open circuit	-	50	200	μA
I <sub>L</sub>	Latching current	$V_{\rm D} = 12 \text{ V}; \text{ I}_{\rm GT} = 0.5 \text{ mA}; \text{ R}_{\rm GK} = 1 \text{ k}\Omega$	-	2	6	mA
I <sub>H</sub>	Holding current	$V_{\rm D} = 12 \text{ V}; I_{\rm GT} = 0.5 \text{ mA}; R_{\rm GK} = 1 \text{ k}\Omega$	-	2	5	mA
İΫ <sub>T</sub>	On-state voltage	$I_T = 2 A$	-	1.35	1.5	V
V <sub>GT</sub>	Gate trigger voltage	$\dot{V}_{\rm D}$ = 12 V; I <sub>T</sub> = 10 mA; gate open circuit	-	0.5	0.8	V
		$V_{\rm D} = V_{\rm DRM(max)}; I_{\rm T} = 10 \text{ mA}; T_{\rm j} = 125 \text{ °C};$	0.2	0.3	-	V
I <sub>D</sub> , I <sub>R</sub>	Off-state leakage current	gate open circuit $V_D = V_{DRM(max)}, V_R = V_{RRM(max)}; T_j = 125 \text{°C};$	-	0.05	0.1	mA
		$R_{GK} = 1 k\Omega$				

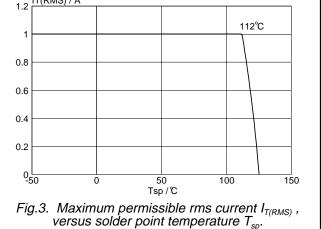
## **DYNAMIC CHARACTERISTICS**

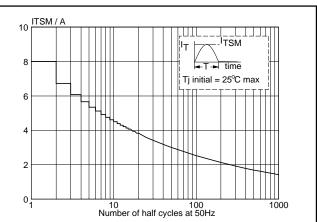
 $T_j = 25$  °C unless otherwise stated

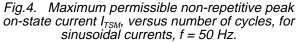
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
dV <sub>D</sub> /dt	Critical rate of rise of off-state voltage	$V_{DM}$ =67% $V_{DRM(max)}$ ; T <sub>j</sub> = 125 °C; exponential waveform; R <sub>GK</sub> = 1k Ω	-	25	-	V/µs
t <sub>gt</sub>	Gate controlled turn-on time	$I_{TM} = 2 \text{ A}; V_D = V_{DRM(max)}; I_G = 10 \text{ mA};$ $dI_G/dt = 0.1 \text{ A}/\mu\text{s}$	-	2	-	μs
t <sub>q</sub>	Circuit commutated turn-off time	$V_{D}^{"} = 67\% V_{DRM(max)}; T_{i} = 125 °C;$ $I_{TM} = 1.6 A; V_{R} = 35 V; dI_{TM}/dt = 30 A/\mu s;$ $dV_{D}/dt = 2 V/\mu s; R_{GK} = 1 k\Omega$	-	100	-	μs

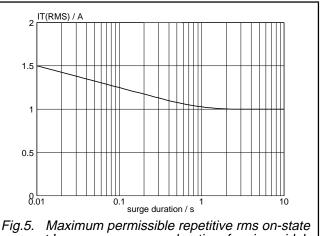
## **BT169W Series**



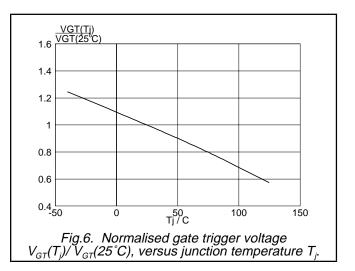




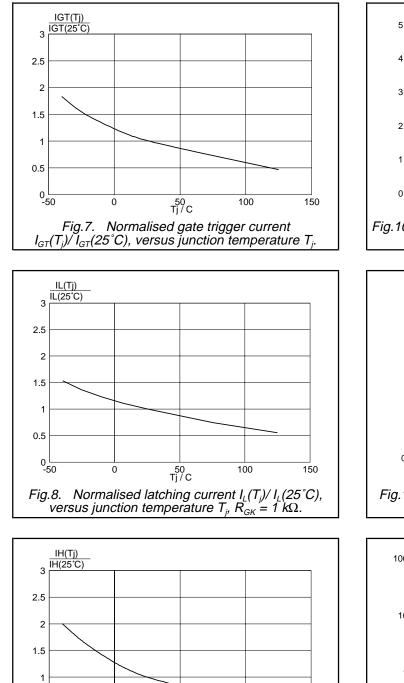


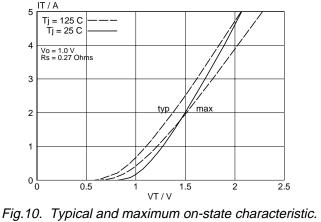


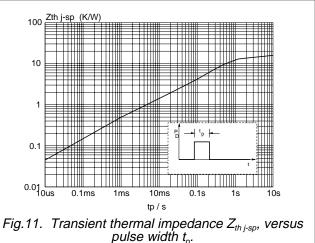
*Fig.5.* Maximum permissible repetitive rms on-state current  $I_{T(RMS)}$ , versus surge duration, for sinusoidal currents, f = 50 Hz;  $T_{sp} \le 112^{\circ}C$ .

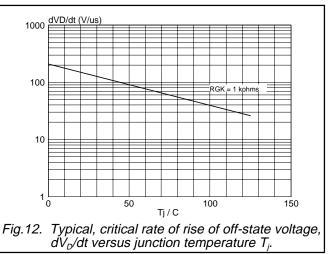


## **BT169W Series**









0.5

0└ -50

0

50 Ti/C

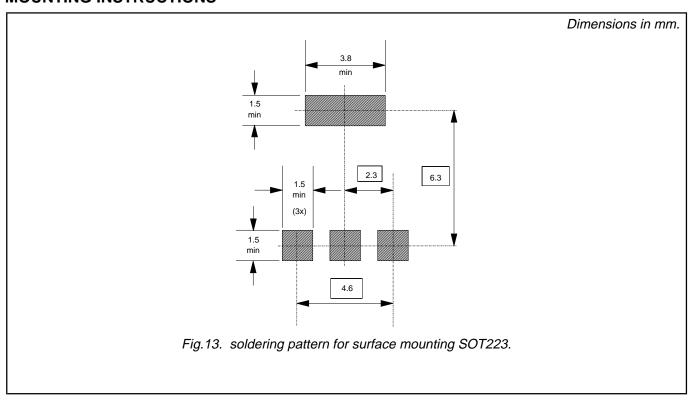
Fig.9. Normalised holding current  $I_{H}(T_{j})/I_{H}(25^{\circ}C)$ , versus junction temperature  $T_{j}$ ,  $R_{GK} = 1 \ k\Omega$ .

100

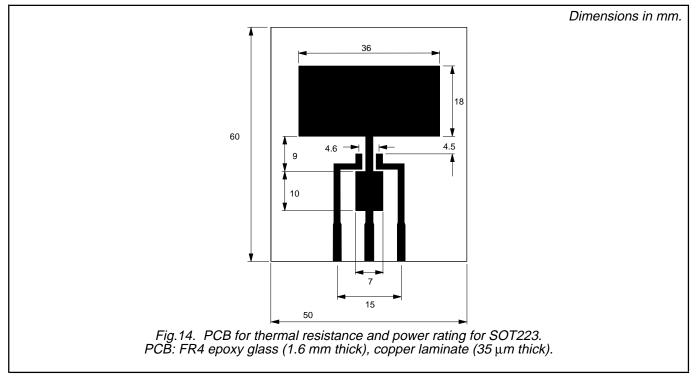
150

## **BT169W Series**

MOUNTING INSTRUCTIONS

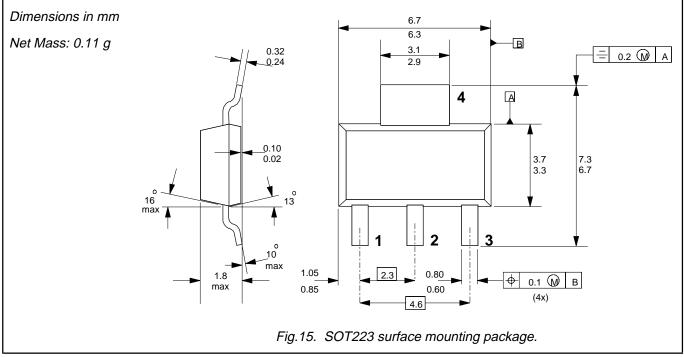


#### PRINTED CIRCUIT BOARD



## **BT169W Series**

#### **MECHANICAL DATA**



#### Notes

For further information, refer to Philips publication SC18 " SMD Footprint Design and Soldering Guidelines". Order code: 9397 750 00505.
Epoxy meets UL94 V0 at 1/8".

Thyristor		<b>BT169W Series</b>
logic level		

#### DEFINITIONS

Data sheet status			
Objective specification This data sheet contains target or goal specifications for product development.			
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.		
Product specification	This data sheet contains final product specifications.		
Limiting values			
Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.			
Application information			

Where application information is given, it is advisory and does not form part of the specification.

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